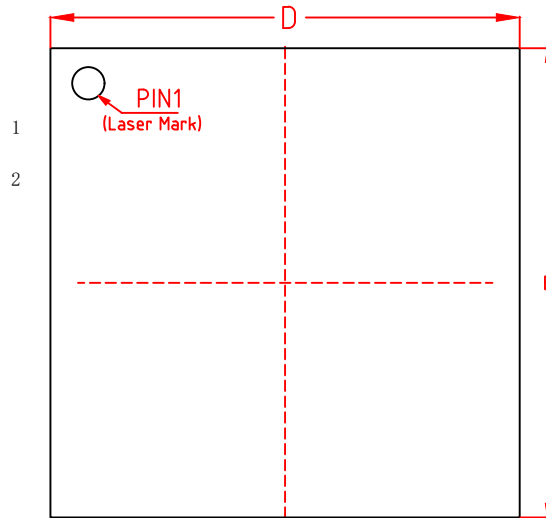
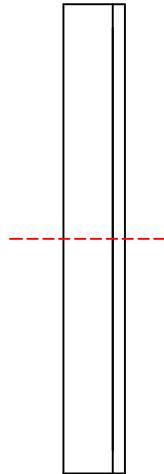


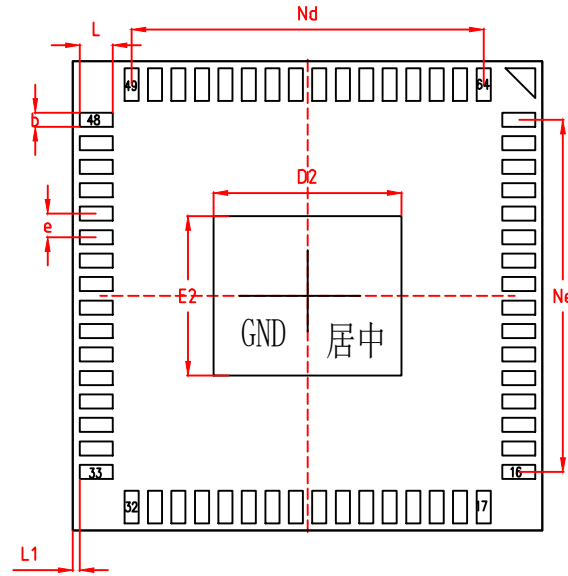
TOP VIEW
正视图



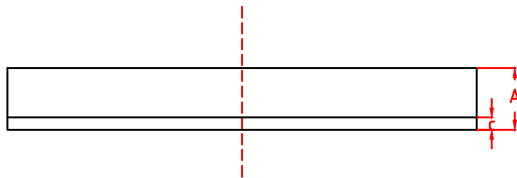
SIDE VIEW
侧视图




BOTTOM VIEW
背视图



SIDE VIEW
侧视图



机械尺寸/mm Dimensions			
字符 SYMBOL	最小值 MIN	典型值 NOMINAL	最大值 MAX
A	1.210	1.310	1.410
c	0.220	0.260	0.300
b	0.250	0.300	0.350
D	9.900	10.000	10.100
D2	3.900	4.000	4.100
E	9.900	10.000	10.100
E2	3.300	3.400	3.500
e	0.500 BSC		
L	0.650	0.70	0.750
L1	0.150 REF		
Ne	7.500BSC		
Nd	7.500BSC		

 池州华宇电子科技股份有限公司 CHI ZHOU HISEMI ELECTRONICS TECHNOLOGY CO.,LTD				制图: Draw	宁林 2023. 10. 19
图号 Drawing NO.	HY-POD-024070090002			制图核查: Drawing review	
Title 产品外形图	PACKAGE OUTLINE DIMENSIONS LGA64L(10.0×10.0×1.31-P0.5)			审核: Checker	
幅图 size	页数 page	单位 unit	比例 scale	视图 view	核准: Approved
A4	1	mm	1:1	